SEARCH REQUEST FORM Scientific and Technical Information Center - EIC2800 This is an experimental format -- Please give suggestions or comments to Jeff Harrison, JEF-4B68, 272-2511. Rev. 3/15/2004 S99 Priority Application Date Your Name Room In what format would you like your results? Paper is the default. PAPER **EMAIL** If submitting more than one search, please prioritize in order of need. The BIC searcher normally will contact you before beginning a prior art search. If you would like to sit with a searcher for an interactive search, please notify one of the searchers. Where have you searched so far on this case? Circle: USPT **DWPI EPO** Abs JPO Abs IBM TDB Other: What relevant art have you found so far? Please attach pertinent citations or Information Disclosure Statements. What types of references would you like? Please checkmark: Primary Refs Nonpatent Literature ____ Secondary Refs / Foreign Patents Teaching Refs ____ What is the topic, such as the novelty, motivation, utility, or other specific facets defining the desired focus of this search? Please include the concepts, synonyms, keywords, acronyms, registry numbers, definitions, structures, strategies, and anything else that helps to describe the topic. Please attach a copy of the abstract and pertinent claims. Staff Use Only Type of Search Vendors Structure (#) Searcher Phone: Bibliographic_ Searcher Location: STIC-EIC2800, JEF-4B68 Litigation

Patent Family

Other_

Searcher Prep/Rev Time:

Online Time:

```
SYSTEM: OS - DIALOG OneSearch
       2:INSPEC 1969-2005/Apr W1
 File
        6:NTIS 1964-2005/Apr W1
        8:Ei Compendex(R) 1970-2005/Apr W1
 File
 File 25:Weldasearch-19662005/Feb (c) 2005 TWI Ltd
 File 31:World Surface Coatings Abs 1976-2005/Mar
 File 34:SciSearch(R) Cited Ref Sci 1990-2005/Apr W1
 File 35:Dissertation Abs Online 1861-2005/Mar
 File 36:MetalBase 1965-20050105
 File 63:Transport Res(TRIS) 1970-2005/
 File 65:Inside Conferences 1993-2005/Apr W2
 File 81:MIRA - Motor Industry Research 2001-2005/Feb
 File 87:TULSA (Petroleum Abs) 1965-2005/Apr W2
 File 94:JICST-EPlus 1985-2005/Feb W4
 File 95:TEME-Technology & Management 1989-2005/Mar W1
 File 96:FLUIDEX 1972-2005/Apr
 File 99: Wilson Appl. Sci & Tech Abs 1983-2005/Mar
 File 103:Energy SciTec 1974-2005/Mar B2
 File 104:AeroBase 1999-2005/Jan
 File 118:ICONDA-Intl Construction 1976-2005/Mar
 File 144: Pascal 1973-2005/Apr W1
 File 239:Mathsci 1940-2005/May
 File 240: PAPERCHEM 1967-2005/Apr W1
 File 248:PIRA 1975-2005/Mar W4
 File 315: ChemEng & Biotec Abs 1970-2005/Mar
 File 323:RAPRA Rubber & Plastics 1972-2005/Mar
 File 434:SciSearch(R) Cited Ref Sci 1974-1989/Dec
 File 350:Derwent WPIX 1963-2005/UD,UM &UP=200523
 File 347: JAPIO Nov 1976-2004/Dec (Updated 050405)
 File 344: Chinese Patents Abs Aug 1985-2004/May
Set
        Items
                Description
                THINN??????(3N) (SEMICOND???????? OR SUBSTRATE?? OR SURFACE-
S1
         6135
S2
         1827
                THINN?????? (8N) SEMICOND???????
s3
        11897
                THINN??????(8N) (SIDE OR SIDES OR BACKSIDE?? OR SURFACE OR -
             SURFACES)
                THINN??????(8N) SUBSTRATE??
         4219
S4
S5
           64
                1AND2AND3AND4
                THINN??????(10N) (EDG???? OR PERIPH??????)
S6
         4908
S7
S8
                THINN??????(10N) (ENCAPSULAT????? OR POLYMER????? OR RESIN?-
             ???? OR SEAL????? OR HERMETIC????)
S 9
            4
                5AND8
               THINN???????(120N) (DIE OR DIES OR DICE OR WAFER?????)
         7179
S10
S11
          18
                5AND10
S12
           3
                5AND8AND10
```

S7 OR S9 OR S11 OR S12

\$14 AND THINN??????/TI

S21 NOT (S18 OR S17)

S14 AND ENCAPSUL????????/TI,AB,DE,ID

S14 AND (RESIN????? OR POLYMER????? OR PARYLEN? OR EPOX???-

THIN??????(1N) (DIE OR DIES OR DICE OR WAFER?????)

RD S13 (unique items)

?) /TI, AB, DE, ID

S18 NOT S17

S14 AND S20

S15:S16

S13

S14

S15

S16

S17

S18

S19

S20

S21

S22

21

21

7

10

5444

11

13apr05 16:36:37 User259284 Session D3149.2

File

2:INSPEC 1969-2005/Apr W1 (c) Institution of Electrical Engineers

Set	Items	Description		
S1	873	(ENCAPSULA???????? OR ENVELOP???????) (5N) (WAFER???? OR DIE		
	OR	DIES OR MICROCHIP?????? OR DICE OR CHIP????)		
S2	575	(ENCAPSULA???????? OR ENVELOP??????) (4N) (RESIN????? OR POLYMER??????)		
s3	66	1AND2		
S4	2	S3 AND LAYERS		
S5	13	S3 AND FILMS		
s6	9	S3 AND TWO		
s7	1	S3 AND SECOND		
\$8	2	S3 AND ANOTHER		
S9	1	S3 AND DOUBLE		
S10	2	S3 AND (BI OR DI)		
S11	0	S3 AND (BILAYER? OR DILAYER?)		
S12	0	S3 AND EDGES		
S13	1	S3 AND EDGE		
S14	0	S3 AND PERIPH?		
S15	27	\$4:\$13		
S16	2	S15/2002-2005		
S17	25	S15 NOT S16		
S18	12	S17 AND (TEST??????? OR PROTECT?????? OR BURN??????? OR INSPECT?????? OR		
DAMAG??????)				
S19	4	DENS????? AND S3		
S20	492	PARYLEN?		
S21	0	S3 AND S20		
S22	6	S1:S2 AND PARYLEN?		
S23	10	S19 OR S22		
S24	10	S23 NOT S18		
S25	1	S24/2003-2005		
S26	9	S24 NOT S25		

```
10/646,897
     CAS/STN FILE 'WPIX, HCAPLUS' ENTERED AT 14:20:26 ON 13 APR 2005
           216 S
                    FARNWORTH?/IN AND WOOD A?/IN
L1
L2
              9
                S
                     L1 AND DOAN T?/IN
                    L2 AND (THIN###### OR ENCAP######### OR DIE)
L3
             9 S
                SEL PLU=ON L3 1- IC RN :
                                              19 TERMS
L4
         227186
L5
               S
                    L4
L6
             9
                S
                    L3 AND L5
ь7
             9 S
                    L2
               SEL PLU=ON L7 1- IC MC FTERM NCL :
F8
                                                         54 TERMS
           4488 S
                    THINN###### (2A) (DIE OR WAFER OR SEMICOND##### OR SUBSTRATE OR BACK OR BACKSIDE OR SIDE OR CHIP
L9.
OR MICROCHIP)
                     (ENCAPSULAT###### OR COVER###### OR PROTECT####) (3A) (EDGES OR PERIPHER##### OR FULL## OR
L10
         74574 S
TOTAL### OR COMPLET######)
L11
         111322 S
                     (DOUBLE OR ANOTHER OR BOTH OR PAIR#####) (3A) (?POLYMER? OR ?PLASTIC? OR ?THERMOSET? OR ?RESIN?
OR RUBBER? OR ELASTOMER? OR PARYLENE?)
         581934 S
                     (TWO OR 2 OR SECOND OR 2ND) (3A) (?POLYMER? OR ?PLASTIC? OR ?THERMOSET? OR ?RESIN? OR RUBBER? OR
ELASTOMER? OR PARYLENE? OR EPOX#### OR POLYIMID#### OR POLYAMID#### OR AMID### OR IMID#### OR ?SILICONE?)
                     (DOUBLE OR ANOTHER OR BOTH OR PAIR#####) (3A) (EPOX#### OR POLYIMID#### OR POLYAMID#### OR
         11732 s
L13
AMID### OR IMID#### OR ?SILICONE?)
                    (ORGANIC#### OR ORG) (4A) (ENCAPSUL####### OR SEAL###### OR HERMETIC##### OR PROTECT#####)
L14
         12925 s
           148 S
                     L9 AND (L10 OR L11 OR L12 OR L13 OR L14)
L15
L16
         459450 S
           767 S
                    L16 AND L9
L17
          18297 s
                    L16 AND (L10 OR L11 OR L12 OR L13 OR L14)
L18
                    L15 OR L17 OR L18
L19
          19142 S
          1032 S
                    L19 AND THINN#########
L20
L21
           2104 S
                    L19 AND (WAFER OR DIE)
L22
            429
                S
                     L20 AND L21
                    L22 AND 25722-33-2
L23
             2 s
             0 S
                     L22 AND DEXTER
L24
             14 S
                     (L9 OR L10 OR L11 OR L12 OR L13 OR L14 OR L15 OR L16 OR L17 OR L18) AND DEXTER
T.25
             53
                S
                     (L9 OR L10 OR L11 OR L12 OR L13 OR L14 OR L15 OR L16 OR L17 OR L18) AND HYSOL
L26
             52 S
                     (L9 OR L10 OR L11 OR L12 OR L13 OR L14 OR L15 OR L16 OR L17 OR L18) AND (FP4450 OR 4450)
L27
L28
             2 S
                     (L9 OR L10 OR L11 OR L12 OR L13 OR L14 OR L15 OR L16 OR L17 OR L18) AND VPES
L29
            102
                S
                     (L23 OR L24 OR L25 OR L26 OR L27 OR L28) AND (L10 OR L11 OR L12 OR L13)
L30
                S
                     L29 AND (VIA OR PIN OR PINN##### OR EDG###(2A)(CONTACT##### OR CONNECT##### OR
INTERCONNECT####) OR REVERS##(2A) BIAS###)
                    L29 AND (?PARYLENE? OR 25722-33-2)
             0 S
L31
              9
                     (L22 OR L23 OR L24 OR L25 OR L26 OR L27 OR L28 OR L29) AND (?PARYLENE? OR 25722-33-2)
L32
                S
              2 S
L33
                    L26 AND L27
L34
             33 s
                    L23 OR L25 OR L28 OR L30 OR L32 OR L33
L35
                SEL PLU=ON L34 1- IC RN :
                                             152 TERMS
     FILE 'LCA' ENTERED AT 15:30:11 ON 13 APR 2005
L36
          7724 S
                    L35
L37
             65 S
                     L36 AND (SEAL####### OR ENCAPS###### OR HERMETIC####)
L38
                SEL PLU=ON L37 1- RN :
                                          248 TERMS
     FILE 'WPIX, JAPIO, HCAPLUS' ENTERED AT 15:31:25 ON 13 APR 2005
                SEL PLU=ON L34 1- PRN :
L39
                                              29 TERMS
     FILE 'HCAPLUS' ENTERED AT 15:37:24 ON 13 APR 2005
L40
            20 S
                    L39
L41
             3 s
                    L40 AND THINN#######
L42
                SEL PLU=ON L41 1- RN :
                                              3 TERMS
L43
          37065
               S
                    L42
L44
                     L41 AND L43
             2
                S
L45
              1
                S
                    L41 NOT L44
     FILE 'JAPIO' ENTERED AT 15:39:03 ON 13 APR 2005
L46
              3 s
                    L39
                     L46 AND THIN######
L47
              2 S
L48
              3
                S
                     (L46 OR L47)
     FILE 'HCAPLUS, JAPIO' ENTERED AT 15:41:03 ON 13 APR 2005
L49
             58 S
                    THINN######## AND (SECOND OR 2ND)(W)(POLYMER#### OR RESIN#### OR ENCAPSU####### OR SEALANT)
                    L49 AND (PIN OR PINN###### OR VIA OR CONTACT#######)
L50
             7 S
L51
              5 S
                     ("FABIANOWSKI W, 1995, V5, P199, ADV MATER OPT ELECTRON"/RE OR "FABIANOWSKI W, 1995, V5, P199,
ADVANCED MATERIALS FOR OPTICS AND ELECTRONICS"/RE)
L52
              0 S
                    L51 AND THIN######
                SEL PLU=ON L51 1- RN :
                                             16 TERMS
L53
        1951077 s
L54
                    T.53
                    L51 AND L54
L55
              5
                S
             55 S
L56
                     (6 OR SIX) (W) SIDES
L57
              0 S
                     L56 AND (L5 OR L16)
L58
              2 S
                    L56 AND SEMICOND#########
```

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10/646,897
    FILE 'WPIX, JAPIO' ENTERED AT 15:45:42 ON 13 APR 2005
           579 S
                    (6 OR SIX)(W) SIDES
            14 S
                    L59 AND SEMICOND#########
            40 S
                    L59 AND (WAFER OR DIE)
                    L59 AND (WAFER AND DIE)
             0 S
            18
               S
                    L59 AND ?POLYMER?
                    L3
             8
               S
               SEL PLU=ON L64 1- PLE :
                                             50 TERMS
         722011 s
                    L65
            11
                    L59 AND L66
                S
                    L60 AND L61
             4 S
             n
                S
                    L60 AND L63
             2
                S
                    L61 AND L63
                    L60 OR L61 OR L63 OR (L67 OR L68 OR L69 OR L70)
             69
               S
                    L71 AND (BACK##### OR REAR)
                S
                    L71 AND ENCAPSUL#########
               S
             1
             5
                s
                    L59 AND ENCAPSUL############
                    (L73 OR L74) NOT L72
             4
               S
             2 s
                    L59 AND ENVELOP######
             1 S
                    L76 NOT (L72 OR L75)
           4293 S
                    (ENVELOP###### OR ENCAPSULAT#######) (4A) (WAFER OR DIE OR CHIP OR MICROCHIP OR SUBSTRATE)
           4553 s
                    L78 OR ENCAPSULA#######(4A) (WAFER OR DIE OR CHIP OR MICROCHIP OR SUBSTRATE)
           785 s
                    L79 AND (EDG### OR PERIPHER#######)
            68
               S
                    L80 AND LAYERS
            23 S
                    L80 AND FILMS
                    L80 AND (POLYMERS OR RESINS OR COPOLYMERS OR MONOMERS OR HOMOPOLYMERS OR PLASTICS OR
           190 S
THERNOPLASTIC? OR THERMOSET? OR ELASTOMER? OR RUBBER##)
            37 s
                    (L81 OR L82) AND L83
                    (L81 OR L82) AND SEMICOND#########
            41 S
           110 S
                    L83 AND SEMICOND#########
            18 s
                    L84 AND L85 AND L86
           777 s
                    (L78 OR L79 OR L80 OR L81 OR L82 OR L83 OR L84 OR L85 OR L86 OR L87) AND ENVELOP##############
             0 s
                    L71 AND ENVELOP##########
           210 S
                    (L71 OR (L78 OR L79 OR L80 OR L81 OR L82 OR L83 OR L84 OR L85 OR L86 OR L87)) AND TEST#########
                    (L71 OR (L78 OR L79 OR L80 OR L81 OR L82 OR L83 OR L84 OR L85 OR L86 OR L87)) AND
           573 S
PROTECT########
             9 S
                    (L71 OR (L78 OR L79 OR L80 OR L81 OR L82 OR L83 OR L84 OR L85 OR L86 OR L87)) AND PHOTOPOLYM?
            36 s
                    (L71 OR (L78 OR L79 OR L80 OR L81 OR L82 OR L83 OR L84 OR L85 OR L86 OR L87)) AND PHOTOSENS?
            98 S
                    (L71 OR (L78 OR L79 OR L80 OR L81 OR L82 OR L83 OR L84 OR L85 OR L86 OR L87)) AND SENSITIVE
                    (L71 OR (L78 OR L79 OR L80 OR L81 OR L82 OR L83 OR L84 OR L85 OR L86 OR L87)) AND
           533 s
RESIST#######
                    (L71 OR (L78 OR L79 OR L80 OR L81 OR L82 OR L83 OR L84 OR L85 OR L86 OR L87)) AND
STEREO############
                    (L71 OR (L78 OR L79 OR L80 OR L81 OR L82 OR L83 OR L84 OR L85 OR L86 OR L87)) AND ?TAPE?
           333 s
           556 S
                    (L71 OR (L78 OR L79 OR L80 OR L81 OR L82 OR L83 OR L84 OR L85 OR L86 OR L87)) AND ?BALĹ?
           312 S
                    (L71 OR (L78 OR L79 OR L80 OR L81 OR L82 OR L83 OR L84 OR L85 OR L86 OR L87)) AND ?BUMP?
             1 S
                    (L71 OR (L78 OR L79 OR L80 OR L81 OR L82 OR L83 OR L84 OR L85 OR L86 OR L87)) AND
REVERS####(5A) BIAS####
            13 S
                    (L71 OR (L78 OR L79 OR L80 OR L81 OR L82 OR L83 OR L84 OR L85 OR L86 OR L87)) AND PARYLEN?
            26 s
                    L72 OR L75 OR L87
           280 S
                    (L90 OR L91 OR L92 OR L93 OR L94 OR L95 OR L96 OR L97 OR L98 OR L99 OR L100 OR L101) AND
(LAYERS OR FILMS OR COATS OR COATINGS OR SUBLAYERS OR SUBCOAT?)
           354 S
                    (L90 OR L91 OR L92 OR L93 OR L94 OR L95 OR L96 OR L97 OR L98 OR L99 OR L100 OR L101) AND
                    (L90 OR L91 OR L92 OR L93 OR L94 OR L95 OR L96 OR L97 OR L98 OR L99 OR L100 OR L101) AND
           634 S
(CONTACTS OR PINS OR VIAS OR BALLS OR BUMPS OR BALLGRIDS OR ARRAYS OR
                                                                                     DENSE####)
                    L103 AND L104
            81 S
            80 S
                    L103 AND L105
                    L103 AND L104 AND L105
            35 S
            27 S
                    L108 NOT L102
            20 S
                    L109 AND (CONTACT OR VIA)
            81 S
                    L66 AND (L106 OR L107 OR L108)
                    L110 OR L102
            46
                s
```

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FILE 'SCISEARCH' ENTERED AT 16:13:19 ON 13 APR 2005
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TEST######### AND L113

L117 NOT (L112 OR L116)

L111 NOT L112

(L114 OR L115)

L113 AND PARYLEN?

"FABIANOWSKI W, 1995, V5, P199, ADV MATER OPT ELECTR"/RE L119 6 S

L113 AND (SIDES OR EDGES OR SURFACES)

L120 0 8 L119 AND SIDES

57

5 S

15 s

19 S

s

S S

L59

L60

L61

L62

L63

L64

L65

L66

L67

L68

L69 L70

L71

L72

L73

L74

1.75

L76

L77

L78

L79

L80

L81

L82

L83

L84

L85

L86

L87

L88

T.89

1.90

L91

L92

L93

L94

L95

L96

L97

L98

L99

L100

L101

L102

L104

L105

L106

L107

L108

L109

L110

L111

L112

L113

L114

L115

L116

L117

L118

POLYMERS

26apr05 15:49:57 User259284 Session D3162.2 File 2:INSPEC 1969-2005/Apr W3

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Set	Items	Description				
S1	118	STEREOIMAG? OR STEREOGRAPH?????(3N)IMAG???????				
S2	1	1 S1 AND (PARYLEN? OR POLYMER? OR PHOTOPOLYMER? OR PHOTORESI-				
	ST?)					
s3	163	(NANO OR STEREO) (W) (LITHOG???????? OR PHOTOLITHOG?)				
S4	2990	STEREOLITHOG????????? OR NANOLITHOG?				
S5		STEREOPHOTOLITHOG????????? OR NANOPHOTOLITHOG?				
S6	608	S3:S5 AND (PARYLEN????? OR POLYMER? OR RESIN?)				
S 7	50	S6 AND (STEREO????????)				
S8	50	S7 NOT S2				
S9	4	S8 AND (NANOCIRCUIT? OR MICROCIRCUIT? OR CIRCUIT????? OR PC				
OR PCS OR PCB? ?)						
S10	10	S8 AND (IC OR ICS OR VLSI OR ULSI OR SCALE()INTEGRAT??????-				
	??)					
S11	14	S9:S10				
S12		S11 NOT S2				
S13		CURING OR POLYMERS OR POLYMERISATION				
S14	356	S1:S8 AND S13				
S15	347	S14 NOT (S11 OR S2)				
S16	19	S15 AND WAFER?				
S17	1	S15 AND (PIN OR PINS)				
S18	42	S15 AND THIN????????				
S 19	48	S15 AND THICK???????				
S 20	2	S15 AND (TAPE?????? OR TAB)				
S21	0	S15 AND UNDERFILL?				
S22	2	S15 AND UNDERNEATH				
S 23	0	S15 AND UNDERSIDE				
S24	29	S15 AND UNDER				
\$25	1	S16:S24 AND OPAQ?				
S26	. 3975	ULTRAVIOLET LITHOGRAPHY (January 1999)				
\$27	26	S16:S24 AND S26				
S 28	25	S27 NOT (S25 OR S12 OR S2)				
S 29	3	S28 AND LAYERS				
S 30	12	S28 AND FILMS				
S31	2	S28 AND COATINGS				
S32	0	S28 AND COATS				
S33	1	S28 AND MULTILAYER?				
.534	0	S28 AND MULTI()LAYER?				
S35	0	S28 AND MULTIPLE() LAYER?				
S 36	14	S29:S35				

26apr05 16:01:37 User259284 Session D3162.3

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SYSTEM: OS - DIALOG OneSearch
       2:INSPEC 1969-2005/Apr W3
         (c) 2005 Institution of Electrical Engineers
         6:NTIS 1964-2005/Apr W3
  File
         8:Ei Compendex(R) 1970-2005/Apr W3
  File
  File 25:Weldasearch-19662005/Mar (c) 2005 TWI Ltd
  File 31:World Surface Coatings Abs 1976-2005/Apr
  File 34:SciSearch(R) Cited Ref Sci 1990-2005/Apr W3
  File 35:Dissertation Abs Online 1861-2005/Mar
  File 36:MetalBase 1965-20050105
         (c) 2005 The Dialog Corporation
  File
        63:Transport Res (TRIS) 1970-2005/
         (c) fmt only 2005 Dialog Corp.
  File 65: Inside Conferences 1993-2005/Apr W4
         (c) 2005 BLDSC all rts. reserv.
  File 81:MIRA - Motor Industry Research 2001-2005/Mar
         (c) 2005 MIRA Ltd.
  File 87:TULSA (Petroleum Abs) 1965-2005/Apr W4
         (c) 2005 The University of Tulsa
  File 94:JICST-EPlus 1985-2005/Mar W2
         (c) 2005 Japan Science and Tech Corp (JST)
  File 95:TEME-Technology & Management 1989-2005/Mar W3
         (c) 2005 FIZ TECHNIK
  File 96:FLUIDEX 1972-2005/Apr
         (c) 2005 Elsevier Science Ltd.
  File 99: Wilson Appl. Sci & Tech Abs 1983-2005/Mar
         (c) 2005 The HW Wilson Co.
  File 103:Energy SciTec 1974-2005/Apr B1
         (c) 2005 Contains copyrighted material
  File 104:AeroBase 1999-2005/Jan
         (c) 2005 Contains copyrighted material
  File 118:ICONDA-Intl Construction 1976-2005/Mar
         (c) 2005 Fraunhofer-IRB
  File 144: Pascal 1973-2005/Apr W3
         (c) 2005 INIST/CNRS
  File 239:Mathsci 1940-2005/Jun
         (c) 2005 American Mathematical Society
  File 240:PAPERCHEM 1967-2005/Apr W3
         (c) 2005 Elsevier Eng. Info. Inc.
  File 248:PIRA 1975-2005/Apr W1
         (c) 2005 Pira International
  File 315: ChemEng & Biotec Abs 1970-2005/Mar
         (c) 2005 DECHEMA
  File 323:RAPRA Rubber & Plastics 1972-2005/Mar
         (c) 2005 RAPRA Technology Ltd
  File 434:SciSearch(R) Cited Ref Sci 1974-1989/Dec
         (c) 1998 Inst for Sci Info
  File 350:Derwent WPIX 1963-2005/UD,UM &UP=200526
         (c) 2005 Thomson Derwent
  File 347: JAPIO Nov 1976-2004/Dec (Updated 050405)
         (c) 2005 JPO € JAPIO
  File 344: Chinese Patents Abs Aug 1985-2004/May
         (c) 2004 European Patent Office
  File 371:French Patents 1961-2002/BOPI 200209
         (c) 2002 INPI. All rts. reserv.
```

Set	Items	Description
S1	3152	PARYLEN?
S2	21	S1 AND THINN?????????
s3	19	RD S2 (unique items)
S4	24	S1 AND OPAQ?
S5	16	RD S4 (unique items)
S6	16	S5 NOT S3

FILE 'INSPEC, WPIX, HCAPLUS, JAPIO, JICST-EPLUS, COMPENDEX, PASCAL, METADEX, CERAB' ENTERED AT 17:00:21 ON 27 APR 2005

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FILE 'INSPEC, WPIX, HCAPLUS, JAPIO, JICST-EPLUS, COMPENDEX, PASCAL,
     METADEX, CERAB, DISSABS' ENTERED AT 17:00:35 ON 27 APR 2005
           1734 SEA ABB=ON PLU=ON PIN(4A) TERMIN####(5A) CONTACT#####
4167 SEA ABB=ON PLU=ON REVERS#####(5A) BIAS####(6A)(HETEROJUNCTION
L1
L2
                 ? OR HOMOJUNCTION? OR JUNCTION? OR PN OR NP OR NPN OR PNP)
              O SEA ABB=ON PLU=ON L1 AND L2
1.3
              O SEA ABB=ON PLU=ON (L1 OR L2) AND PHOTOPOLYMER#####
L4
              1 SEA ABB=ON PLU=ON (L1 OR L2) AND PARYLENE?
L5
                 D TI
                 D ALL
              1 SEA ABB=ON PLU=ON (L1 OR L2) AND 25722-33-2
L6
            223 SEA ABB=ON PLU=ON (L1 OR L2) AND (ORGANIC OR PLASTIC? OR
T.7
                 THERMOPLASTIC? OR THERMOSET? OR RESIN###### OR POLYMER? OR
                 COPOLYMER? OR HOMOPOLYMER? OR MONOMER?)
               6 SEA ABB=ON PLU=ON L7 AND DIE
L8
             24 SEA ABB=ON PLU=ON L7 AND LAYERS
L9
             13 SEA ABB=ON PLU=ON L7 AND FILMS
L10
              4 SEA ABB=ON PLU=ON L7 AND ENCAPSUL#######
L11
             30 SEA ABB=ON PLU=ON (L1 OR L2) AND (ORGANIC OR PLASTIC? OR
L12
                 THERMOPLASTIC? OR THERMOSET? OR RESIN###### OR POLYMER? OR
                 COPOLYMER? OR HOMOPOLYMER? OR MONOMER?) (4A) (LAYER OR FILM)
     FILE 'STNGUIDE' ENTERED AT 17:12:21 ON 27 APR 2005
     FILE 'WPIX' ENTERED AT 17:13:01 ON 27 APR 2005
                E 1988-335756/AN
               1 SEA ABB=ON PLU=ON 88-335756/AN
L13
                 D MAX
     FILE 'DPCI' ENTERED AT 17:13:51 ON 27 APR 2005
                E JP 63250482/PN
               1 SEA ABB=ON PLU=ON JP63250482/PN
L14
                 D ALL
     FILE 'STNGUIDE' ENTERED AT 17:14:51 ON 27 APR 2005
     FILE 'DPCI' ENTERED AT 17:16:22 ON 27 APR 2005
                 E JP 63250482/PN.D
               2 SEA ABB=ON PLU=ON JP63250482/PN.D
L15
                 D ALL TOT
     FILE 'STNGUIDE' ENTERED AT 17:16:36 ON 27 APR 2005
     FILE 'INSPEC, WPIX, HCAPLUS, JAPIO, JICST-EPLUS, COMPENDEX, PASCAL,
     METADEX, CERAB, DISSABS' ENTERED AT 17:20:36 ON 27 APR 2005
              60 SEA ABB=ON PLU=ON (L8 OR L9 OR L10 OR L11 OR L12)
              47 DUP REM L16 (13 DUPLICATES REMOVED)
15 SEA ABB=ON PLU=ON L17 AND THIN########
6 SEA ABB=ON PLU=ON L17 AND SIDES
L17
L18
L19
              21 SEA ABB=ON PLU=ON (L18 OR L19)
L20
                 D TI 1-21
                 D ALL 1-7 14-21
                 D MAX 8-13
              10 SEA ABB=ON PLU=ON L8 OR L11
L21
              10 DUP REM L21 (0 DUPLICATES REMOVED)
1.22
              7 SEA ABB=ON PLU=ON L22 NOT L20
L23
```

```
FILE 'WPIX, HCAPLUS' ENTERED AT 14:36:47 ON 26 APR 2005
Ll
               1 S US6717245/PN
             SEL L1 1- PN :
                                  1 TERM
1.2
      FILE 'DPCI' ENTERED AT 14:36:59 ON 26 APR 2005
              0 S US6717245/PN.D
1.3
              27 S US6717245/PN.G
L4
                                 78 TERMS
L5
             SEL L4 1- PN :
             627 S L5/PN.D
Ъб
      FILE 'WPIX, HCAPLUS' ENTERED AT 14:39:36 ON 26 APR 2005
             SEL L1 1- IC :
1.7
                                  1 TERM
      FILE 'DPCI' ENTERED AT 14:39:51 ON 26 APR 2005
            4063 S L7
L8
L9
              73 S L6 AND L8
              8 S L6 AND SIDES
L10
               0 S L6 AND ENVELOP?
1.11
               0 S L6 AND THINN#######
L12
              89 S L6 AND DIE
L13
              94 S L6 AND (RESIN#### OR ?POLYMER? OP SEAL###### OR ENCAPS#####
L14
              96 S L6 AND (RESIN##### OR POLYMER? OR SEAL####### OR ENCAPS######
 L15
=> s 113 and 114-15
 L16
             12 L13 AND (L14 OR L15)
 => s 19 and 113-14
            23 L9 AND (L13 OR L14)
 => s 19 and L15
             10 L9 AND L15
- L18
 => s 110 or 116-18
L19
             40 L10 OR (L16 OR L17 OR L18)
 => sel prn
    SmartSELECT INITIATED
 New TRANSFER and ANALYZE Commands Now Available
 See HELP TRANSFER and HELP ANALYZE for Details
                                   66 TERMS
            SEL L19 1- PRN :
L20
```

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L21 126 L20

=> s 121 and thinn####### L22 3 L21 AND THINN########

=> s 121 and envelop?

L23 0 L21 AND ENVELOP?

=> s 121 and encapsul?

L24 26 L21 AND ENCAPSUL?

------ 4/26/05 10/646,897 ------

=> s 121 and seal?

L25 28 L21 AND SEAL?

=> s 121 and complete?

L26 5 L21 AND COMPLETE?

=> s l21 and total?

L27 1 L21 AND TOTAL?

=> s 121 and surround?

L28 3 L21 AND SURROUND?

=> s 121 and entire?

L29 3 L21 AND ENTIRE?

=> s 121 and covered

L30 5 L21 AND COVERED

 \Rightarrow s 124-25 and bottom and top

L31 3 (L24 OR L25) AND BOTTOM AND TOP

=> s 124-25 and side

L32 19 (L24 OR L25) AND SIDE

=> s 122 or 126-32

L33 36 L22 OR (L26 OR L27 OR L28 OR L29 OR L30 OR L31 OR L32)